

10 mm x 10 mm C-plane n-type high-transparency AMMONO-GaN substrate, oxygen-doped.  
The substrate is sliced from a mono-crystalline bulk material grown by ammonothermal method.

**TECHNICAL SPECIFICATION**

DESCRIPTION	UNIT	VALUE
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**General specification**

Orientation		(0001) C plane
Thickness	μm	350 (±50)
Dimension(s)	mm	10 (±0,5) x 10 (±0,5)
Primary Flat (PF)	mm	3 (±0,5)
Secondary Flat (SF)	mm	1,5 (±0,5)
Bow	μm	0 (±10)
Total Thickness Variation (TTV)	μm	≤ 20

**Structural specification**

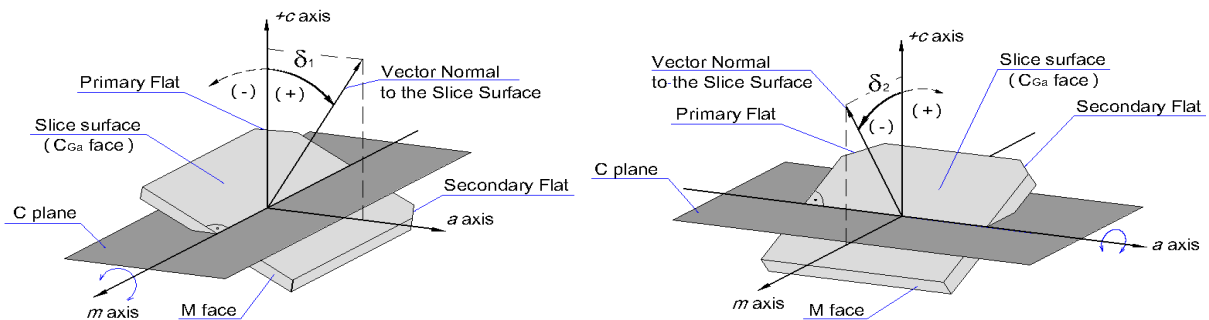
Etch Pit Density (EPD)	cm <sup>-2</sup>	< 5 x 10 <sup>4</sup>
FWHM (0002) of X-ray rocking curve, epi-ready surface at 100 μm x 100 μm slit	arcsec	~ 20
Macrodefects		none

**Electrical specification**

Type of conductivity		n type
Carrier concentration	cm <sup>-3</sup>	2 x 10 <sup>17</sup> - 2 x 10 <sup>18</sup>
Resistivity	Ω*cm	10 <sup>-2</sup> - 10 <sup>-1</sup>
Carrier mobility	cm <sup>2</sup> /V*s	~ 200 - 250

**MISORIENTATION**

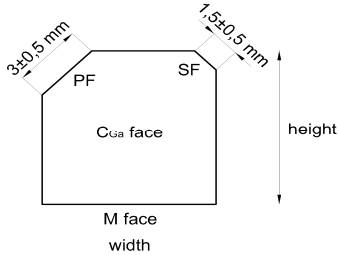
(measured in the center of the substrate)



Off M face		deg	0 (±0,25)
C face	angle δ <sub>1</sub>	deg	0 (±0,20)
	angle δ <sub>2</sub>	deg	±0,3 (±0,20)

**SURFACE PREPARATION**

Front side		Epi-ready polished (RMS < 0,5 nm)
Back side		Ground

**SUBSTRATE SHAPE**


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